524,288 WORD × 8 BIT CMOS UV ERASABLE AND ELECTRICALLY PROGRAMMABLE READ ONLY MEMORY

# **PRELIMINARY**

#### DESCRIPTION

The TC544000P/F is a 524,288 word  $\times$  8 bit one time programmable read only memory, and molded in a 32 pin plastic package. The access time of TC544000P/F is 120ns/150ns and has low power standby mode which reduces the power dissipation without increasing access time.

The electrical characteristics and programming method are the same as U.V. EPROM TC574000D's once programmed, the TC544000P/F cannot be erased because of using plastic DIP without transparent window.

# **FEATURES**

• Peripheral circuit

: CMOS

Memory cell

: N-MOS

• Access time

_	- 12	- 120	- 150	
Vcc	5V ± 5%	5V ± 10%		
Temp		0°C~70°C		
tACC	120ns		150ns	

• Low power dissipation

Active: 60mA/8.3MHz Standby: 100µA (Ta=70°C)

- High speed programming operation
- Single 5V power supply
- Full static operation
- Input and output TTL compatible
- JEDEC standard 32 pin
- Standard 32 pin DIP plastic package: TC544000P

32 pin plastic Flat Package: TC544000F

# PIN CONNECTION (TOP VIEW)

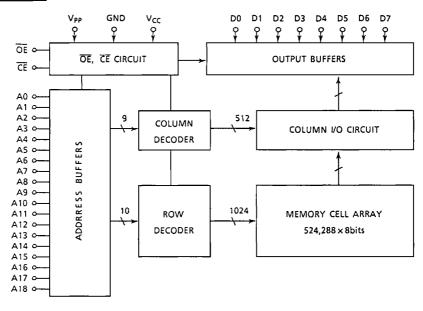
	_				
Vpp	Ţ١	_	32	þ	٧cc
A16	ď٤		31	b	A18
A15	Цз		30	b	A17
A12	ď٩		29	6	A14
A7	ds		28	6	A13
A6	Дe		27	6	8A
A5	ď		26	6	A9
A4	d.		25	6	All
A3			24	h	ŌĒ
AZ	ď	0	24 23	6	A10 CE D7 D6
Al	ď	1	22	6	Œ
AO	П,	2	21	Б	D7
DO	٦,	3	20	ħ	D6
DI	Я,	Δ	19	ĥ	D5
D2		5	18	ĥ	D4
GND	Ħ,	•	17	ĸ	D3
GNU	4'	•	"	ľ	

TC544000P/F

# PIN NAMES

A0~A18	Address Inputs
D0~D7	Outputs (inputs)
CE	Chip Enable Input
ŌĒ	Output Enable Input
Vcc	V <sub>CC</sub> Supply Voltage
Vpp	Program Supply Voltage
GND	Ground

# **BLOCK DIAGRAM**



#### MODE SELECTION

MODE	CE	ŌĒ	V <sub>PP</sub>	Vcc	D0~D7	Power
Read	L	L			Data Out	Active
Output Deselect	•	Н			High Impedance	Active
Standby	Н	*	1	Ì	High Impedance	Standby
Program	L	н			Data In	
Program Inhibit	н	н	12.50V	6.25V	High Impedance	Active
Program Verify	*	L		Data Out		]

<sup>\*</sup>: H or L

# MAXIMUM RATINGS

SYMBOL	ITEM	RATING	UNIT
V <sub>C</sub> Ç	V <sub>CC</sub> Power Supply Voltage	-0.6~7.0	V
V <sub>PP</sub>	Program Supply Voltage	- 0.6~14.0	V
VIN	Input Voltage	- 0.6~7.0	V
V <sub>IN</sub> (A9)	Input Voltage (A9)	-0.6~13.5	V
V <sub>I/O</sub>	Input/Output Voltage	-0.6~V <sub>CC</sub> +0.5	V
PD	Power Dissipation	1.5	W
TSOLDER	Soldering Temperature · Time	260 • 10	°C · sec
T <sub>strg</sub>	Storage Temperature	- 65~125	°C
Topr	Operating Temperature	0~70	°C

# **READ OPERATION**

#### DC RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	TC544000P/F - 12	TC544000P/F - 120/ - 150
V <sub>iH</sub>	Input High Voltage	2.2V~V <sub>CC</sub> + 0.3V	2.2V~V <sub>CC</sub> + 0.3V
V <sub>IL</sub>	Input Low Voltage	- 0.3V~0.8V	0.3V~0.8V
Vcc	V <sub>CC</sub> Power Supply Voltage	5V ± 5%	5V ± 10%
Vpp	V <sub>PP</sub> Power Supply Voltage	V <sub>CC</sub> = 0.6V~V <sub>CC</sub> + 0.6V	V <sub>CC</sub> = 0.6V~V <sub>CC</sub> + 0.6V

#### DC AND OPERATING CHARACTERISTICS (Ta=0~70°C)

SIMBOL	PARAMETER	TEST CONDITION		MIN.	TYP.	MAX.	UNIT
lu	Input Current	V <sub>IN</sub> = 0~V <sub>CC</sub>		-	-	± 10	μА
		CE = V <sub>IL</sub>	f = 8.3MHz	-	-	60	
lcco1	Operating Current		f = 6.7MHz	_	_	50	mA
l <sub>CCO2</sub>			f = 1MHz	-	-	15	
I <sub>CCS1</sub>		CE = VIH		-	-	1	mA
I <sub>CCS2</sub>	Standby Current	$\overline{CE} = V_{CC} - 0.$	2V	-	-	100	μΑ
VoH	Output High Voltage	I <sub>OH</sub> = - 400µ	A	2.4	-	-	V
Vol	Output Low Voltage	i <sub>OL</sub> = 2.1mA		-	-	0.4	V
lpp1	V <sub>PP</sub> Current	V <sub>PP</sub> = V <sub>CC</sub> ± 0.6V		_	-	± 10	μА
ILO	Output Leakage Current	V <sub>OUT</sub> = 0.4V~V <sub>CC</sub>			-	± 10	μА

# AC CHARACTERISTICS ( $Ta=0\sim70^{\circ}C$ , $V_{PP}=V_{CC}\pm0.6V$ )

CIMPOL	DADAMETER	TEST COMPLETION	TC544000P/F-12/-120		TC544000	TINU	
SHAROL	SIMBOL PARAMETER	TEST CONDITION	MIN.	MAX.	MIN.	MAX.	UNII
t <sub>ACC</sub>	Address Access Time	$\overline{CE} = \overline{OE} = V_{IL}$	_	120	-	150	ns
t <sub>CE</sub>	CE to Output Valid	OE = VIL		120		150	ns
t <sub>OE</sub>	OE to Output Valid	CE = V <sub>IL</sub>	_	60	_	70	ns
t <sub>DF1</sub>	CE to Output in High-Z	OE = V <sub>IL</sub>	0	50	0	60	ns
t <sub>OF2</sub>	OE to Output in High-Z	CE = VIL	0	50	0	60	ns
t <sub>OH</sub>	Output Data Hold Time	CE = OE = V <sub>IL</sub>	0	_	0	_	ns

#### AC TEST CONDITIONS

• Output Load : 1 TTL Gate and C<sub>L</sub>=100pF

Input Pulse Rise and Fall Times : 10ns Max.
 Input Pulse Levels : 0.45V~2.4V

• Timing Measurement Reference Level: Inputs 0.8V and 2.2V, Outputs 0.8V and 2.0V

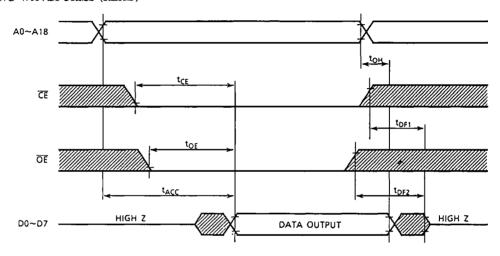


# CAPACITANCE\* (Ta=25°C, f=1MHz)

SYMBOL	PARAMETER	TEST CONDITION	MIN.	MAX.	UNIT
C <sub>IN</sub>	Input Capacitance	V <sub>IN</sub> = 0V	-	9	PF
C <sub>OUT</sub>	Output Capacitance	V <sub>OUT</sub> = 0V	-	13	Pr

<sup>\*</sup>This parameter is periodically sampled and is not 100% tested.

# TIMING WAVEFORMS (READ)



# HIGH SPEED PROGRAM OPERATION

#### DC RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	MIN.	TYP.	MAX.	UNIT
V <sub>IH</sub>	Input High Voltage	2.2	-	V <sub>CC</sub> + 1.0	٧
V <sub>IL</sub>	Input Low Voltage	- 0.3	-	0.8	٧
V <sub>CC</sub>	V <sub>CC</sub> Power Supply Voltage	6.00	6.25	6.50	٧
Vpp	V <sub>PP</sub> Power Supply Voltage	12.20	12.50	12.80	V

# DC AND OPERATING CHARACTERISTICS ( $Ta = 25 \pm 5^{\circ}\text{C}$ , $V_{CC} = 6.25 \text{V} \pm 0.25 \text{V}$ , $V_{PP} = 12.50 \text{V} \pm 0.30 \text{V}$ )

SYMBOL	PARAMETER	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
l <sub>ti</sub>	Input Current	V <sub>IN</sub> = 0~V <sub>CC</sub>		-	± 10	μA
V <sub>OH</sub>	Output High Voltage	I <sub>OH</sub> = - 400μA	2.4	-	_	٧
VoL	Output Low Voltage	I <sub>OL</sub> = 2.1mA	-	-	0.4	٧
lcc	V <sub>CC</sub> Supply Current	-	-	_	30	mA
lpp2	V <sub>PP</sub> Supply Current	V <sub>PP</sub> = 12.8V	-	-	50	mA

# AC PROGRAMMING CHARACTERISTICS (Ta=25±5°C, V<sub>CC</sub>=6.25V±0.25V, V<sub>PP</sub>=12.50V±0.30V)

SYMBOL	PARAMETER	TEST CONDITION	MIN.	TYP.	ĕ4X.	UNIT
tas	Address Setup Time	-	2	-	-	μs
t <sub>AH</sub>	Address Hold Time		2	-	-	μs
t <sub>CES</sub>	CE Setup Time	-	0	-	_	μs
t <sub>CEH</sub>	CE Hold Time	-	0	_	-	μς
toes	OE Set up Time	-	2		_	μs
tos	Data Set up Time	-	2	-	-	μs
t <sub>DH</sub>	Data Hold Time	-	2	-	-	μs
typs	V <sub>PP</sub> Set up Time	-	2	-	-	μ\$
tvcs	V <sub>CC</sub> Set up Time	-	2	_	_	μs
tpw	Program Pulse Width	$\overline{CE} = V_{1L}, \ \overline{OE} = V_{1H}$	45	50	55	ħε
t <sub>OE</sub>	OE to Output Valid	CE = VIH	-	-	100	ns
topp	OE to Output in High-Z	CE = VIH	_	-	90	ns

#### AC TEST CONDITIONS

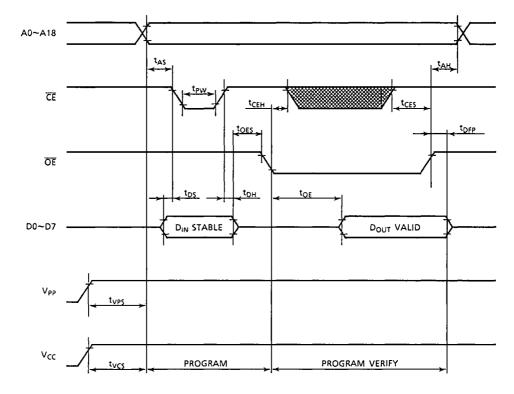
• Output Load : 1 TTL Gate and CL (100pF)

Input Pulse Rise and Fall Time : 10ns Max.
 Input Pulse Levels : 0.45V~2.4V

• Timing Measurement Reference Level: Input 0.8V and 2.2V, Output 0.8V and 2.0V

#### TIMING WAVEFORMS (PROGRAM)

#### HIGH SPEED PROGRAM OPERATION



Note 1. VCC must be applied simultaneously or before Vpp and cut off simultaneously or after Vpp.

- 2. Removing the device from socket and setting the device in socket with VPP=12.50V may cause permanent damage to the device.
- 3. The VPP supply voltage is permitted up to 14V for program operation. So the voltage over 14V should not be applied to the VPP terminal. When the switching pulse voltage is applied to the VPP terminal, the overshoot voltage of its pulse should not be exceeded 14V.

#### OPERATION INFORMATION

The TC544000P/F's six operation modes are listed in the following table. Mode selection can be achieved by applying TTL level signal to all inputs.

MODE	PIN NAMES (NUMBER)	CE (22)	OĒ (24)	V <sub>PP</sub> (1)	V <sub>CC</sub> (32)	D0~D7 (13~15, 17~21)	POWER	
Read Operation (Ta = 0~70°C)	Read	L	L			Data Out	Active	
	Output Deselet	*	н	5∨	5V	High Impedance		
	Standby	Н	*			High Impedance	Standby	
Program Operation (Ta = 25 ± 5°C)	Program	L	Н		6.25V	Data in	Active	
	Program Inhibit	Н	н	12.50∨		High Impedance		
	Program Verify	*	L			Data Out		

Note: H; VIH, L: VIL, \*: VIH or VIL

#### READ MODE

The TC544000P/F has two control functions. The chip enable  $(\overline{CE})$  controls the operation power and should be used for device selection. The output enable  $(\overline{OE})$  controls the output buffers, independent of device selection. Assuming that  $\overline{CE} = \overline{OE} = V_{IL}$ , the output data is valid at the outputs after address access time from stabilizing of all addresses. The  $\overline{CE}$  to output valid (tCE) is equal to the address access time (tACC).

Assuming that  $\overline{CE} = V_{IL}$  and all addresses are valid, the output data is valid at the outputs after toe from the falling edge of  $\overline{OE}$ .

#### OUTPUT DESELECT MODE

Assuming that  $\overline{CE} = V_{IH}$  or  $\overline{OE} = V_{IH}$ , the outputs will be in a high impedance state. So two or more TC544000P/F's can be connected together on a common bus line. When  $\overline{CE}$  is decoded for device selection, all deselected devices are in low power standby mode.

#### STANDBY MODE

The TC544000P/F has a low power standby mode controlled by the  $\overline{\text{CE}}$  signal. By applying a high level to the  $\overline{\text{CE}}$  input, the TC544000P/F is placed in the standby mode which reduce the operating current to 100 $\mu$ A by applying MOS-high level (V<sub>CC</sub>) and then the outputs are in a high impedance state, independent of the  $\overline{\text{OE}}$  inputs.

### PROGRAM MODE

Initially, when received by customers, all bits of the TC544000P/F are in the "1" state which is erased state. Therefore the program operation is to introduce "0's" data into the desired bit locations by electrically programming. The TC544000P/F is in the programming mode when the  $V_{PP}$  input is at 12.50V and  $\overline{CE}$  is at Low under  $\overline{OE} = V_{IH}$ .

The TC544000P / F can be programmed any location at any time either individually, sequentially, or at random.

#### PROGRAM VERIFY MODE

The verify mode is to check that desired data is correctly programmed on the programmed bits. The verify is accomplished with  $\overline{\text{OE}}$  at  $V_{IL}$ .

#### PROGRAM INHIBIT MODE

Under the condition that the program voltage (+12.50V) is applied to Vpp terminal, a high level  $\overline{CE}$  and  $\overline{OE}$  input inhibits the TC544000P/F from being programmed.

Programming of two or more TC544000P / F's in parallel with different data is easily accomplished. That is, all inputs except for  $\overline{CE}$  and  $\overline{OE}$  may be commonly connected, and a low level program pulse is applied to the  $\overline{CE}$  of the desired device only and high level signal is applied to the other devices.

#### HIGH SPEED PROGRAM MODE

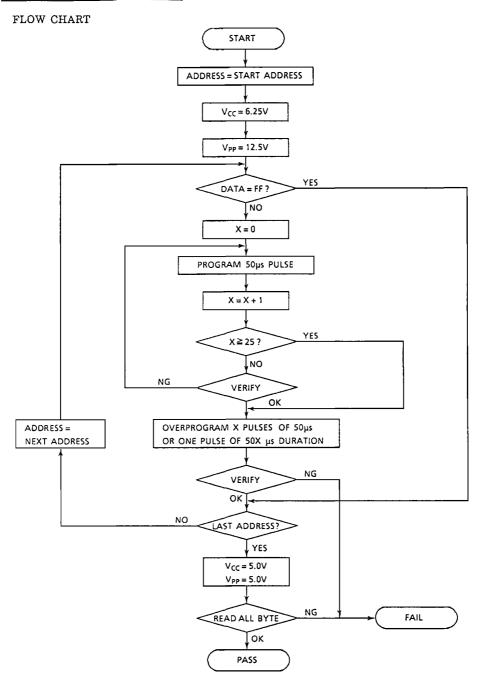
The device is set up in the high speed programming mode when the programming voltage (+12.50V) is applied to the Vpp terminal with  $V_{CC} = 6.25V$ .

The programming is achieved by applying a single low level 50µs pulse to the  $\overline{\text{CE}}$  input after addresses and data are stable. Then the programmed data is verified by using Program Verify Mode. If the programmed data is not correct, another program pulse of 50µs is applied and then the programmed data is verified. This should be repeated until the program operates correctly (max. 25 times).

After correctly programming the selected address, the additional program pulse with width of 1 time more than that needed for initial programming is applied.

When programming has been completed, the data in all addresses should be verified with  $V_{CC} = V_{PP} = 5V$ .

# HIGH SPEED PROGRAM MODE





# ELECTRIC SIGNATURE MODE

Electric signature mode allows to read out a code from TC544000P/F which identifies its manufacturer and device type.

The programming equipment may read out manufacturer code and device code from TC544000P/F by using this mode before program operation and automatically set program voltage (Vpp) and algorithm.

Electric Signature mode is set up when 12V is applied to address line A9 and the rest of address lines is set to  $V_{\rm IL}$  in read operation. Data output in this condition is manufacturer code. Device code is identified when address A0 is set to  $V_{\rm IH}$ .

These two codes possess an odd parity with the parity bit of MSB (D7).

The following table shows electric signature of TC544000P/F.

PINS	Α0	D7	D6	D5	D4	D3	D2	D1	D0	HEX. DATA
Manufacture Code	VIL	1	0	0	1	1	٥	0	0	98
Device Code	VIH	1	0	0	0	1	1	0	0	8C

Notes:  $A9 = 12V \pm 0.5V$ 

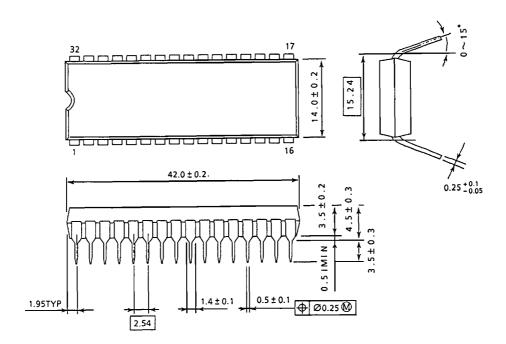
A1~A8, A10~A18,  $\overrightarrow{CE}$ ,  $\overrightarrow{OE} = V_{IL}$ 

# **OUTLINE DRAWINGS**

• Plastic DIP

DIP32-P-600

Unit:mm



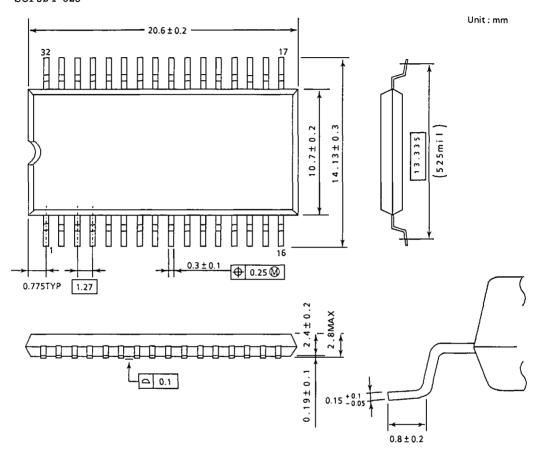


Note: Package width and length do not include mold protrusion, allowable mode protrusion is 0.15mm.

# **OUTLINE DRAWINGS**

• Plastic SOP

SOP32-P-525



Note: Package width and length do not include mold protrusion, allowable mode protrusion is 0.15mm.